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Revision History

Revision	Revision History
V1.0	First release

Safety Instructions

- Always read the safety instructions carefully.
- Keep this User's Manual for future reference.
- Keep this equipment away from humidity.
- Lay this equipment on a reliable flat surface before setting it up.
- The openings on the enclosure are for air convection hence protects the equipment from overheating. DO NOT COVER THE OPENINGS.
- Make sure the voltage of the power source is at 110/220V before connecting the
 equipment to the power intelled.
- Place the power cord such a way that people can not step on it. Do not place anything over the power cord.
- Always Unplug the Power Cord before inserting any add-on card or module.
- All cautions and warnings on the equipment should be noted.
- Never pour any liquid into the opening that can cause damage or cause electrical shock.
- If any of the following situations arises, get the equipment checked by service personnel:
 - The power cord or plug is damaged.
 - Liquid has penetrated into the equipment.
 - O The equipment has been exposed to moisture.
 - The equipment does not work well or you can not get it work according to User's Manual.
 - The equipment has been dropped and damaged.
 - The equipment has obvious sign of breakage.
- DO NOT LEAVE THIS EQUIPMENT IN AN ENVIRONMENT ABOVE 60°C (140°F), IT MAY DAMAGE THE EQUIPMENT.

Battery Information



European Union:

Batteries, battery packs, and accumulators should not be disposed of as unsorted household waste. Please use the public collection system to return, recycle, or treat them in compliance with the local regulations.



Taiwan:

For better environmental protection, waste batteries should be collected separately for recycling or special disposal.



California, USA:

The button cell battery may contain perchlorate material and requires special handling when recycled or disposed of in California.

CAUTION: There is a risk of explosion, if battery is incorrectly replaced. Replace only with the same or equivalent type recommended by the manufacturer.

FCC-B Radio Frequency Interference Statement

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the measures listed below.

- O Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- O Consult the dealer or an experienced radio/television technician for help.

Notice 1

The changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

Notice 2

Shielded interface cables and A.C. power cord, if any, must be used in order to comply with the emission limits.



This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:

- 1) this device may not cause harmful interference, and
- this device must accept any interference received, including interference that may cause undesired operation.

CE Conformity

Hereby, Micro-Star International CO., LTD declares that this device is in compliance with the essential safety requirements and other relevant provisions set out in the European Directive.





Radiation Exposure Statement

This equipment complies with FCC radiation exposure limits set forth for an uncontrolled environment. This equipment and its antenna should be installed and operated with minimum distance 20 cm between the radiator and your body. This equipment and its antenna must not be co-located or operating in conjunction with any other antenna or transmitter.

European Community Compliance Statement

The equipment complies with the RF Exposure Requirement 1999/519/EC, Council Recommendation of 12 July 1999 on the limitation of exposure of the general public to electromagnetic fields (0–300GHz). This wireless device complies with the R&TTE Directive.

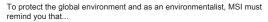
Chemical Substances Information

In compliance with chemical substances regulations, such as the EU REACH Regulation (Regulation EC No. 1907/2006 of the European Parliament and the Council), MSI provides the information of chemical substances in products.

WEEE Statement

WEEE (Waste Electrical and Electronic Equipment)

ENGLISH



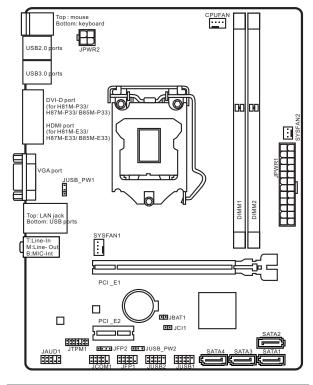


Under the European Union ("EU") Directive on Waste Electrical and Electronic Equipment, Directive 2002/96/EC, which takes effect on August 13, 2005, products of "electrical and electronic equipment" cannot be discarded as municipal wastes anymore, and manufacturers of covered electronic equipment will be obligated to take back such products at the end of their useful life. MSI will comply with the product take back requirements at the end of life of MSI-branded products that are sold into the EU. You can return these products to local collection points.

English

Thank you for choosing the H81M-P33/ H81M-E33/ H87M-P33/ H87M-E33/ B85M-P33/ B85M-E33 Series (MS-7817 v1.X) Micro-ATX motherboard. The H81M-P33/ H81M-E33/ H87M-P33/ H87M-E33/ B85M-P33/ B85M-P33 Series motherboards are based on Intel H81/ H87/ B85 chipset for optimal system efficiency. Designed to fit the advanced Intel LGA1150 processor, the H81M-P33/ H81M-E33/ H87M-P33/ H8

Layout



Motherboard Specifications

CPU Support	■ 4th Generation Intel® Core™ i7 / Core™ i5 / Core™ i3 / Pentium® / Celeron® processors for LGA 1150 socket		
Chipset	■ Intel® H81/ H87/ B85 Express Chipset		
Memory Support	2x DDR3 memory slots supporting up to 16GB Supports DDR3 1600/ 1333/ 1066 MHz Dual channel memory architecture Supports non-ECC, un-buffered memory		
Expansion Slots	■ 1x PCle x16 slot (optional) ■ 1x PCle 2.0 x1 slot		
Onboard Graphics	 1x HDMI port (optional), supporting a maximum resolution of 2560x1600@60Hz, 24bpp/ 1920x1080@60Hz, 36bpp 1x DVI-D port (optional), supporting a maximum resolution of 1920x1200 @ 60Hz, 24bpp 1x VGA port, supporting a maximum resolution of 1920x1200 @ 60Hz, 24bpp 		
Storage	■ Intel H81/ H87/ B85 Express Chipset - 4x SATA ports (optional) - Supports RAID 0, RAID1, RAID 5 and RAID 10 (optional) - Supports Intel Smart Response Technology (optional)* - Supports Intel Rapid Start Technology (optional)* - Supports Intel Smart Connect Technology (optional)* * Supports Intel Core processors on Windows 7 and Windows 8		
USB	Intel H81/ H87/ B85 Express Chipset 2x USB 3.0 ports on the back panel 8x USB 2.0 ports (4 ports on the back panel, 4 ports available through the internal USB connectors*)		
Audio	■ Realtek® ALC887 Codec		
LAN	■ Realtek® RTL8111G Gigabit LAN controller		
Back Panel Connectors	 1x PS/2 keyboard port 1x PS/2 mouse port 4x USB 2.0 ports 2x USB 3.0 ports 1x HDMI port (optional) 1x DVI-D port (optional) 1x VGA port 1x LAN (RJ45) port 3x audio jacks 		

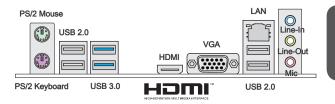
Internal Connectors	 1x 24-pin ATX main power connector 1x 4-pin ATX 12V power connector 4x SATA connectors 2x USB 2.0 connectors (supports additional 4 USB 2.0 ports) 1x 4-pin CPU fan connector 1x 4-pin system fan connector 1x 3-pin system fan connector 1x Front panel audio connector 2x System panel connectors 1x Chassis Intrusion connector 1x Clear CMOS jumper 2x USB power jumpers
BIOS Features	 UEFI AMI BIOS ACPI 5.0, PnP 1.0a, SM BIOS 2.7, DMI 2.0 Multi-language
Form Factor	■ Micro-ATX Form Factor ■ 8.9 in. x 6.8 in. (22.6 cm x 17.3 cm)

Optional Specifications

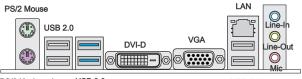
Name	H81M-P33	H81M-E33	H87M-P33
Specification			
PCle x16 slot	Gen2	Gen2	Gen3
DVI-D/ HDMI	DVI-D	HDMI	DVI-D
SATA1, SATA2	SATA 6Gb/s	SATA 6Gb/s	SATA 6Gb/s
SATA3, SATA4	SATA 3Gb/s	SATA 3Gb/s	SATA 6Gb/s
BIOS ROM	64Mb	64Mb	128Mb
RAID	Not supported	Not supported	Supported
Small Business Advantage	Not supported	Not supported	Supported
Intel Rapid Start	Not supported	Not supported	Supported
Intel Smart Response	Not supported	Not supported	Supported
Intel Smart Connect	Supported	Supported	Supported

Name	H87M-E33	B85M-P33	B85M-E33
Specification	1107141-200	BOOM-1 OO	200111 200
PCle x16 slot	Gen3	Gen3	Gen3
DVI-D/ HDMI	HDMI	DVI-D	HDMI
SATA1, SATA2	SATA 6Gb/s	SATA 6Gb/s	SATA 6Gb/s
SATA3, SATA4	SATA 6Gb/s	SATA 3Gb/s	SATA 3Gb/s
BIOS ROM	128Mb	128Mb	128Mb
RAID	Supported	Not supported	Not supported
Small Business Advantage	Supported	Supported	Supported
Intel Rapid Start	Supported	Supported	Supported
Intel Smart Response	Supported	Not supported	Not supported
Intel Smart Connect	Supported	Supported	Supported

H81M-E33/ H87M-E33/ B85M-E33

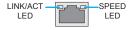


H81M-P33/ H87M-P33/ B85M-P33



PS/2 Keyboard USB 3.0 USB 2.0

LAN LED Indicator

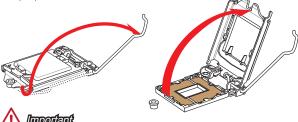


LED	LED Status	Description
	Off	No link
Link/ Activity LED	Yellow	Linked
	Blinking	Data activity
	Off	10 Mbps connection
Speed LED	Green	100 Mbps connection
	Orange	1 Gbps connection

CPU & Heatsink Installation

When installing a CPU, always remember to install a CPU heatsink. A CPU heatsink is necessary to prevent overheating and maintain system stability. Follow the steps below to ensure correct CPU and heatsink installation. Wrong installation can damage both the CPU and the motherboard.

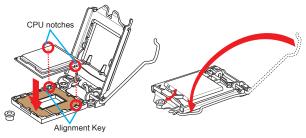
- Push the load lever down to unclip it and lift to the fully open position.
- 2. The load plate will automatically lift up as the load lever is pushed to the fully open position.



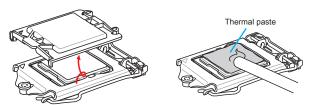
Important

Do not touch the socket contacts or the bottom of the CPU.

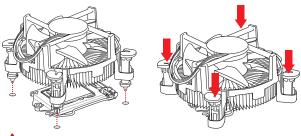
- 3. Align the notches with the socket alignment keys. Lower the CPU straight down, without tilting or sliding the CPU in the socket. Inspect the CPU to check if it is properly seated in the socket.
- 4. Close and slide the load plate under the retention knob. Close and engage the load lever.



- When you press down the load lever the PnP cap will automatically pop up from the CPU socket. Do not discard the PnP cap. Always replace the PnP cap if the CPU is removed from the socket.
- Evenly spread a thin layer of thermal paste (or thermal tape) on the top of the CPU. This will help in heat dissipation and prevent CPU overheating.



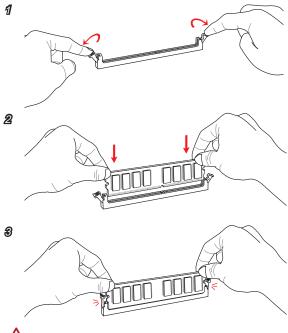
- 7. Locate the CPU fan connector on the motherboard.
- 8. Place the heatsink on the motherboard with the fan's cable facing towards the fan connector and the fasteners matching the holes on the motherboard.
- Push down the heatsink until the four fasteners get wedged into the holes on the motherboard. Press the four fasteners down to fasten the heatsink. As each fastener locks into position a click should be heard.
- Inspect the motherboard to ensure that the fastener-ends have been properly locked in place.
- 11. Finally, attach the CPU fan cable to the CPU fan connector on the motherboard.





Important

- Confirm that the CPU heatsink has formed a tight seal with the CPU before booting your system.
- Whenever the CPU is not installed, always protect the CPU socket pins by covering the socket with the plastic cap.
- If you purchased a separate CPU and heatsink/ cooler, Please refer to the documentation in the heatsink/ cooler package for more details about installation.



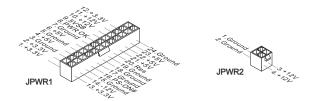
/!\ Important

- DDR3 memory modules are not interchangeable with DDR2, and the DDR3 standard is not backward compatible. Always install DDR3 memory modules in DDR3 DIMM slots.
- To ensure system stability, memory modules must be of the same type and density in Dual-Channel mode.

Internal Connectors

JPWR1~2: ATX Power Connectors

These connectors allow you to connect an ATX power supply. To connect the ATX power supply, align the power supply cable with the connector and firmly press the cable into the connector. If done correctly, the clip on the power cable should be hooked on the motherboard's power connector.





Important

Make sure that all the power cables are securely connected to a proper ATX power supply to ensure stable operation of the motherboard.

JCOM1: Serial Port Connector

This connector is a 16550A high speed communication port that sends/receives 16 bytes FIFOs. You can attach a serial device.



SATA1~4: SATA Connectors

This connector is a high-speed SATA interface port. Each connector can connect to one SATA device. SATA devices include disk drives (HDD), solid state drives (SSD), and optical drives (CD/ DVD/ Blu-Ray).





Important

- Many SATA devices also need a power cable from the power supply. Such devices include disk drives (HDD), solid state drives (SSD), and optical drives (CD / DVD / Blu-Ray). Please refer to the device's manual for further information.
- Many computer cases also require that large SATA devices, such as HDDs, SSDs, and optical drives, be screwed down into the case. Refer to the manual that came with your computer case or your SATA device for further installation instructions.
- Please do not fold the SATA cable at a 90-degree angle. Data loss may result during transmission otherwise.
- SATA cables have identical plugs on either sides of the cable. However, it is recommended that the flat connector be connected to the motherboard for space saving purposes.

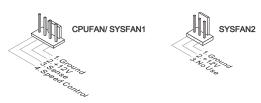
JCI1: Chassis Intrusion Connector

This connector connects to the chassis intrusion switch cable. If the computer case is opened, the chassis intrusion mechanism will be activated. The system will record this intrusion and a warning message will flash on screen. To clear the warning, you must enter the BIOS utility and clear the record.



CPUFAN.SYSFAN1~2: Fan Power Connectors

The fan power connectors support system cooling fans with +12V. If the motherboard has a System Hardware Monitor chipset on-board, you must use a specially designed fan with a speed sensor to take advantage of the CPU fan control. Remember to connect all system fans. Some system fans may not connect to the motherboard and will instead connect to the power supply directly. A system fan can be plugged into any available system fan connector.



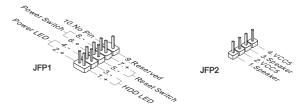


Important

- Please refer to your processor's official website or consult your vendor to find recommended CPU heatsink.
- These connectors support Smart Fan Control with liner mode. The Command Center utility can be installed to automatically control the fan speeds according to the CPU's and system's temperature.
- If there are not enough ports on the motherboard to connect all system fans, adapters are available to connect a fan directly to a power supply.
- Before first boot up, ensure that there are no cables impeding any fan blades.

JFP1, JFP2: System Panel Connectors

These connectors connect to the front panel switches and LEDs. The JFP1 connector is compliant with the Intel® Front Panel I/O Connectivity Design Guide. When installing the front panel connectors, please use the optional M-Connector to simplify installation. Plug all the wires from the computer case into the M-Connector and then plug the M-Connector into the motherboard.



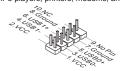


Important

- On the connectors coming from the case, pins marked by small triangles are
 positive wires. Please use the diagrams above and the writing on the optional MConnectors to determine correct connector orientation and placement.
- The majority of the computer case's front panel connectors will primarily be plugged into JFP1.

JUSB1~2: USB 2.0 Expansion Connectors

This connector is designed for connecting high-speed USB peripherals such as USB HDDs, digital cameras, MP3 players, printers, modems, and many others.



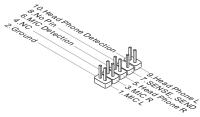


Important

Note that the VCC and GND pins must be connected correctly to avoid possible damage.

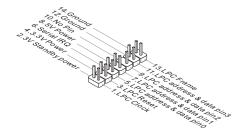
JAUD1: Front Panel Audio Connector

This connector allows you to connect the front audio panel located on your computer case. This connector is compliant with the Intel® Front Panel I/O Connectivity Design Guide



JTPM1: TPM Module Connector

This connector connects to a TPM (Trusted Platform Module). Please refer to the TPM security platform manual for more details and usages.



JBAT1: Clear CMOS Jumper

There is CMOS RAM onboard that is external powered from a battery located on the motherboard to save system configuration data. With the CMOS RAM, the system can automatically boot into the operating system (OS) every time it is turned on. If you want to clear the system configuration, set the jumpers to clear the CMOS RAM.





Keep Data

Clear Data



You can clear the CMOS RAM by shorting this jumper while the system is off. Afterwards, open the jumper. Do not clear the CMOS RAM while the system is on because it will damage the motherboard.

JUSB_PW1, JUSB_PW2: USB Power Jumper

These jumpers are used to assign which USB and PS/2 ports could support "Wake Up Event Setup" field of BIOS.

JUSB_PW1

(for back panel USB ports & PS/2 ports)



unnort



No Support (Default)

JUSB_PW2

(for onboard USB connectors)

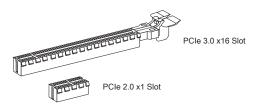


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No Support (Default)

PCI_E1~2: PCIe Expansion Slots

The PCIe slot supports the PCIe interface expansion card.





When adding or removing expansion cards, always turn off the power supply and unplug the power supply power cable from the power outlet. Read the expansion card's documentation to check for any necessary additional hardware or software changes.

BIOS Setup

The default settings offer the optimal performance for system stability in normal conditions. You may need to run the Setup program when:

- An error message appears on the screen during the system booting up, and requests you to run SETUP.
- You want to change the default settings for customized features.



Important

- Please load the default settings to restore the optimal system performance and stability if the system becomes unstable after changing BIOS settings. Select the "Restore Defaults" and press <Enter> in BIOS to load the default settings.
- If you are unfamiliar with the BIOS settings, we recommend that you keep the default settings to avoid possible system damage or failure booting due to inappropriate BIOS configuration.

Entering BIOS Setup

Power on the computer and the system will start the Power On Self Test (POST) process. When the message below appears on the screen, please key to enter BIOS:

Press DEL key to enter Setup Menu, F11 to enter Boot Menu

If the message disappears before you respond and you still need to enter BIOS, restart the system by turning the computer OFF then back ON or pressing the RESET button. You may also restart the system by simultaneously pressing <Ctrl>, <AII>, and <Delete> keys.

MSI additionally provides two methods to enter the BIOS setup. You can click the "GO2BIOS" tab on "MSI Fast Boot" utility screen or press the physical "GO2BIOS" button (optional) on the motherboard to enable the system going to BIOS setup directly at next boot.



Click "GO2BIOS" tab on "MSI Fast Boot" utility screen.



Important

Please be sure to install the "MSI Fast Boot" utility before using it to enter the BIOS setup.

Overview

After entering BIOS, the following screen is displayed.



OC Menu





Important

- · Overclocking your PC manually is only recommended for advanced users.
- Overclocking is not guaranteed, and if done improperly, can void your warranty or severely damage your hardware.
- If you are unfamiliar with overclocking, we advise you to use OC Genie for easy overclocking.

▶ Current CPU/ DRAM/ Ring Frequency

These items show the current frequencies of installed CPU, Memory and Ring. Read-only.

► CPU Ratio Mode [Auto]

Selects the CPU Ratio operating mode.

[Auto] This setting will be configured automatically by BIOS.

[Fixed Mode] Fixes the CPU ratio.

[Dynamic Mode] CPU ratio will be changed dynamically according to the CPU

loading.

Adjust CPU Ratio [Auto]

Sets the CPU ratio that is used to determine CPU clock speed. This item can only be changed if the processor supports this function.

► Adjusted CPU Frequency

Shows the adjusted CPU frequency. Read-only.

► EIST [Enabled]

Enables or disables the Enhanced Intel® SpeedStep Technology.

► Intel Turbo Boost [Enabled]

Enables or disables the Intel® Turbo Boost. This item appears when the installed CPU supports this function.

[Enabled] Enables this function to boost CPU performance automatically

above rated specifications when system request the highest

performance state.

[Disabled] Disables this function.

► Enhanced Turbo [Auto]

Enables or disables Enhanced Turbo function for all CPU cores to boost CPU performance.

[Auto] This setting will be configured automatically by BIOS.

[Enabled] All CPU cores would be increased to maximum turbo ratio.

[Disabled] Disables this function.

Adjust Ring Ratio [Auto]

Sets the ring ratio. The valid value range depends on the installed CPU.

Adjusted Ring Frequency

Shows the adjusted Ring frequency. Read-only.

► Adjust GT Ratio [Auto]

Sets the integrated graphics ratio. The valid value range depends on the installed CPU.

► Adjusted GT Frequency

Shows the adjusted integrated graphics frequency. Read-only.

DRAM Frequency [Auto]

Sets the DRAM frequency. Please note the overclocking behavior is not guaranteed.

► Adjusted DRAM Frequency

Shows the adjusted DRAM frequency. Read-only.

► DRAM Timing Mode [Auto]

Selects the memory timing mode.

[Auto] DRAM timings will be determined based on SPD (Serial Presence

Detect) of installed memory modules.

[Link] Allows user to configure the DRAM timing manually for all memory

channel.

[UnLink] Allows user to configure the DRAM timing manually for respective

memory channel.

► Advanced DRAM Configuration

Press <Enter> to enter the sub-menu. This sub-menu will be activated after setting [Link] or [Unlink] in "DRAM Timing Mode". User can set the memory timing for each memory channel. The system may become unstable or unbootable after changing memory timing. If it occurs, please clear the CMOS data and restore the default settings. (Refer to the Clear CMOS jumper/ button section to clear the CMOS data, and enter the BIOS to load the default settings.)

► Memory Fast Boot [Auto]

Enables or disables the initiation and training for memory every booting.

[Auto] This setting will be configured automatically by BIOS.

[Enabled] Memory will completely imitate the archive of first initiation and

first training. After that, the memory will not be initialed and trained

when booting to accelerate the system booting time.

[Disabled] The memory will be initialed and trained every booting.

► DRAM Voltage [Auto]

Sets the memory voltage. If set to "Auto", BIOS will set memory voltage automatically or you can set it manually.

► Spread Spectrum

This function reduces the EMI (Electromagnetic Interference) generated by modulating clock generator pulses.

[Enabled] Enables the spread spectrum function to reduce the EMI

(Electromagnetic Interference) problem.

[Disabled] Enhances the overclocking ability of CPU Base clock.



lmoortent

- If you do not have any EMI problem, leave the setting at [Disabled] for optimal system stability and performance. But if you are plagued by EMI, select the value of Spread Spectrum for EMI reduction.
- The greater the Spread Spectrum value is, the greater the EMI is reduced, and the system will become less stable. For the most suitable Spread Spectrum value, please consult your local EMI regulation.
- Remember to disable Spread Spectrum if you are overclocking because even a slight jitter can introduce a temporary boost in clock speed which may just cause

your overclocked processor to lock up.

CPU Features

Press <Enter> to enter the sub-menu.

► Hyper-Threading Technology [Enabled]

The processor uses Hyper-Threading technology to increase transaction rates and reduces end-user response times. Intel Hyper-Threading technology treats the multi cores inside the processor as multi logical processors that can execute instructions simultaneously. In this way, the system performance is highly improved.

[Enable] Enables Intel Hyper-Threading technology.

[Disabled] Disables this item if the system does not support HT function.

► Active Processor Cores [All]

This item allows you to select the number of active processor cores.

► Limit CPUID Maximum [Disabled]

Enables or disables the extended CPUID value.

[Enabled] BIOS will limit the maximum CPUID input value to circumvent boot problems with older operating system that do not support

the processor with extended CPUID value.

[Disabled] Use the actual maximum CPUID input value.

► Execute Disable Bit [Enabled]

Intel's Execute Disable Bit functionality can prevent certain classes of malicious "buffer overflow" attacks where worms attempt to execute code to damage the system. It is recommended that keeps this item enabled always.

[Enabled] Enables NO-Execution protection to prevent the malicious

attacks and worms.

Disables this function.

► Intel Virtualization Tech [Enabled]

[Disabled]

Enables or disables Intel Virtualization technology.

[Enabled] Enables Intel Virtualization technology and allows a platform

to run multiple operating systems in independent partitions.

The system can function as multiple systems virtually.

[Disabled] Disables this function.

► Hardware Prefetcher [Enabled]

Enables or disables the hardware prefetcher (MLC Streamer prefetcher).

[Enabled] Allows the hardware prefetcher to automatically pre-fetch

data and instructions into L2 cache from memory for tuning

the CPU performance.

[Disabled] Disables the hardware prefetcher.

► Adjacent Cache Line Prefetch [Enabled]

Enables or disables the CPU hardware prefetcher (MLC Spatial prefetcher).

[Enabled] Enables adjacent cache line prefetching for reducing the

cache latency time and tuning the performance to the specific

application.

[Disabled] Enables the requested cache line only.

CPU AES Instructions [Enabled]

Enables or disables the CPU AES (Advanced Encryption Standard-New Instructions) support. This item appears when a CPU supports this function.

[Enabled] Enables Intel AES support. [Disabled] Disables Intel AES support.

► Intel Adaptive Thermal Monitor [Enabled]

Enables or disables the Intel adaptive thermal monitor function to protect the CPU from overheating.

[Enabled] Throttles down the CPU core clock speed when the CPU is

over the adaptive temperature.

[Disabled] Disables this function.

► Intel C-State [Auto]

C-state is a processor power management technology defined by ACPI. [Auto] This setting will be configured automatically by BIOS.

[Enabled] Detects the idle state of system and reduce CPU power

consumption accordingly.

[Disabled] Disable this function.

► C1E Support [Disabled]

Enables or disables the C1E function for power-saving in halt state. This item appears when "Intel C-State" is enabled.

[Enabled] Enables C1E function to reduce the CPU frequency and

voltage for power-saving in halt state.

[Disabled] Disables this function.

► Package C State limit [Auto]

This item allows you to select a CPU C-state mode for power-saving when system is idle. This item appears when "Intel C-State" is enabled.

[Auto] This setting will be configured automatically by BIOS.

[C0~C7s] The power-saving level from high to low is C7s, C7, C6, C3,

C2 then C0

[No limit] No C-state limit for CPU.

LakeTiny Feature [Disabled]

Enables or disables Intel Lake Tiny feature with iRST for SSD. This item appears when a installed CPU supports this function and "Intel C-State" is enabled.

[Enabled] Enhance the dynamic IO load adjusted performance for

accelerating the SSD speed.

[Disabled] Disables this feature.

Note: The following items will appear when "Intel Turbo Boost" is enabled.

► Long Duration Power Limit (W) [Auto]

Sets the long duration TDP power limit for CPU in Turbo Boost mode.

► Long Duration Maintained (s) [Auto]

Sets the maintaining time for "Long duration power Limit(W)".

► Short Duration Power Limit (W) [Auto]

Sets the short duration TDP power limit for CPU in Turbo Boost mode.

► CPU Current limit (A) [Auto]

Sets maximum current limit of CPU package in Turbo Boost mode. When the current is over the specified limit value, the CPU will automatically reduce the core frequency for reducing the current.

► 1/2/3/4-Core Ratio Limit [Auto]

These items only appear when a CPU that support this function is installed. These items allow you to set the CPU ratios for different number of active cores in turbo boost mode. These items appear when the installed processor supports this function.